

### **Features**

- Halogen Free. "Green" Device (Note 1)
- Glass Passivated Chip Junction
- Low Profile Package
- For Surface Mount Applications
- Super Fast Reverse Recovery Time
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Lead Free Finish/RoHS Compliant (Note 2)("P" Suffix Designates RoHS Compliant. See Ordering Information)

# 3 Amp Super Fast Recovery Rectifier 200 to 800 Volts

### Maximum Ratings @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Value					
Parameter	Symbol	ER3DBFL	ER3GBFL	ER3JBFL	ER3KBFL	Unit	
Peak Repetitive Reverse Voltage	$V_{RRM}$						
Working Peak Reverse Voltage	$V_{RWM}$	200	400	600	800	V	
DC Blocking Voltage	$V_R$						
RMS Reverse Voltage	V <sub>RMS</sub>	140	280	420	560	V	
Average Rectified Forward Current @ T <sub>L</sub> =55°C	I <sub>F(AV)</sub>	3			А		
Non-Repetitive Peak Surge Current @8.3ms Half Sine Wave	I <sub>FSM</sub>	100			А		
Current Squared Time @1ms≤t≤8.3ms	l <sup>2</sup> t	41.5			A <sup>2</sup> s		

## **Marking Code**

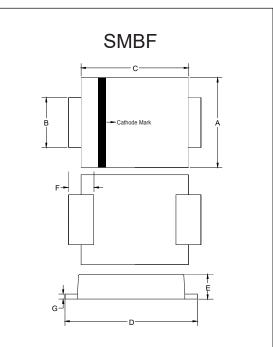
Part Number	Marking Code	
ER3DBFL	ER3D	
ER3GBFL	ER3G	
ER3JBFL	ER3J	
ER3KBFL	ER3K	

### **Internal Structure**

Simplified Outline	Graphic Symbol
1 MCC XXXX 2 XXXX = Marking code	1 ∘ ✓ ✓ ∘ 2

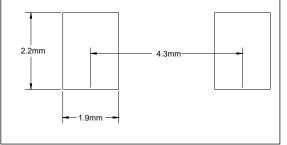
Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

2. High Temperature Solder Exemption Applied, see EU Directive Annex 7a.



DIMENSIONS					
DIM INC		HES	M <sub>M</sub>		NOTE
DIIVI	MIN		MIN	MAX	NOIL
Α	0.134	0.150	3.40	3.80	
В	0.075	0.083	1.90	2.10	
С	0.163	0.175	4.15	4.45	
D	0.201	0.220	5.10	5.60	
Е	0.041	0.061	1.05	1.55	
F	0.028	0.053	0.70	1.35	
G	0.006	0.010	0.15	0.25	

#### Suggested Solder Pad Layout





### Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$T_J$	Operating Junction Temperature Range		-55		150	°C
T <sub>stg</sub>	Storage Temperature Range		-55		150	°C
Rth <sub>(J-L)</sub>	Thermal Resistance from Junction to Lead	Note 1		20		°C/W
Rth <sub>(J-A)</sub>	Thermal Resistance from Junction to Ambient	Note 1		60		°C/W

Note:

# Electrical Characteristics @ 25°C Unless Otherwise Specified

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage						
ER3DBF	L V <sub>F</sub>	I <sub>F</sub> =3A;T <sub>J</sub> =25°C			0.95	
ER3GBF	L				1.30	V
ER3JBF	L				1.70	
ER3KBF	L				1.85	
Reverse Current	I <sub>R</sub>	at Rated V <sub>R</sub> ;T <sub>J</sub> =25°C at Rated V <sub>R</sub> ;T <sub>J</sub> =125°C			5 100	μА
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =0.5A; I <sub>R</sub> =1.0A; I <sub>rr</sub> =0.25A;T <sub>J</sub> =25°C			35	ns
Junction Capacitance						
ER3DBF	L C <sub>J</sub>	V <sub>R</sub> =4V;f=1MHz;T <sub>J</sub> =25°C		60		
ER3GBF				35		pF
ER3JBF				29		
ER3KBF	L			21		

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<sup>1.</sup>Mounted on P.C.B. with 8mm\*8mm copper pad areas.



Forward Current (A)

0.01 \_\_\_\_

0.3

0.6

### **Curve Characteristics**

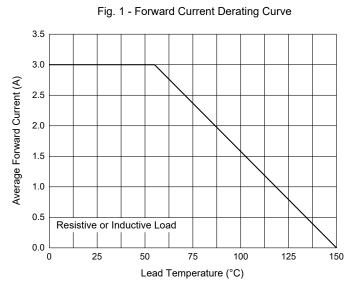


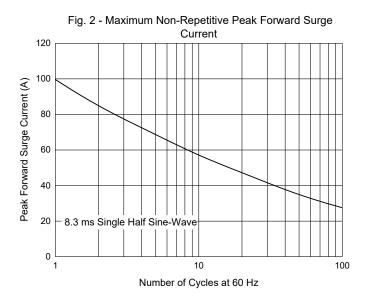
Fig. 3 - Typical Forward Characteristics 10 T<sub>J</sub>=25°C =75°C \( \equiv \) =125°C =

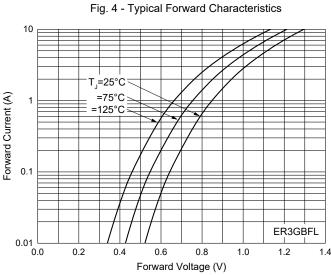
**ER3DBFL** 0.01 0.0 0.2 0.4 0.6 8.0 1.0 1.2 Forward Voltage (V) Fig. 5 - Typical Forward Characteristics 10 T,=25°C =75°C Forward Current (A) =125°C

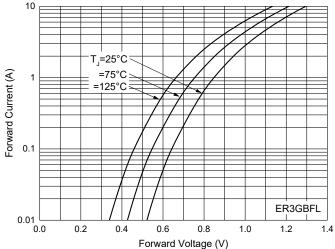
0.9

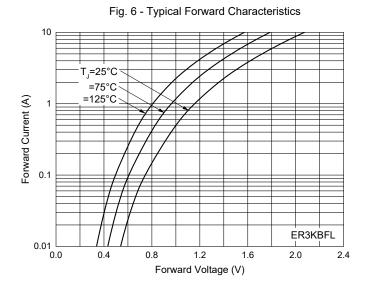
Forward Voltage (V)

1.2









ER3JBFL

1.8

1.5



### **Curve Characteristics**

Fig. 7 - Typical Reverse Leakage Characteristics

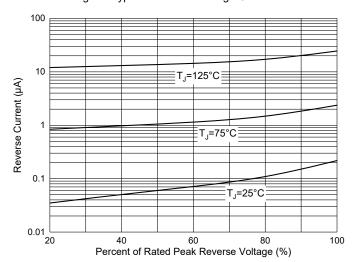
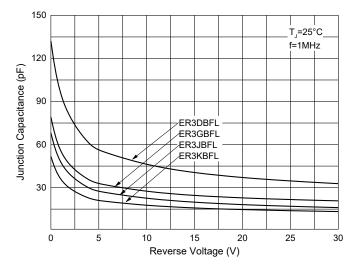


Fig. 8 - Typical Capacitance Characteristics





### **Ordering Information**

Device	Packing		
Part Number-TP	Tape&Reel:5Kpcs/Reel		

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